



#### SURFACE MOUNT SWITCHING DIODE ARRAY

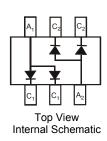
#### Features

- Fast Switching Speed
- Ultra-Small Surface Mount Package
- For General Purpose Switching Applications
- **High Conductance**
- Two "BAW56" Circuits In One Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standard for High Reliability

#### **Mechanical Data**

- Case: SOT363
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208 @3
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagram
- Weight: 0.006 grams (approximate)

Top View



#### Ordering Information (Note 4)

Part Number	Case	Packaging
BAW56DW-7-F	SOT363	3000/Tape & Reel
BAW56DWQ-7-F	SOT363	3000/Tape & Reel

SOT363

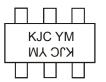
Notes:

 No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

### Marking Information



KJC = Product Type Marking Code YM = Date Code Marking Y = Year ex: N = 2002 M = Month ex: 9 = September

Date Code Key	<u>/</u>													
Year	2002	2003		200	8 2009	2010	2011	2012	2013	2014	2015	2016	2017	2018
Code	Ν	Р		V	W	Х	Y	Z	А	В	С	D	E	F
Month	Jan	Fe	b	Mar	Apr	Мау	Jun	Jul	Aug	I Se	эp	Oct	Nov	Dec
Code	1	2		3	4	5	6	7	8	ę	9	0	Ν	D



## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V <sub>RM</sub>	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	75	V
RMS Reverse Voltage		V <sub>R(RMS)</sub>	53	V
Forward Continuous Current	(Note 5)	I <sub>FM</sub>	300	mA
Average Rectified Output Current	(Note 5)	lo	150	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0µs @ t = 1.0s	I <sub>FSM</sub>	2.0 1.0	А

## **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 5)	PD	200	mW
Thermal Resistance Junction to Ambient Air	(Note 5)	R <sub>θJA</sub>	625	°C/W
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

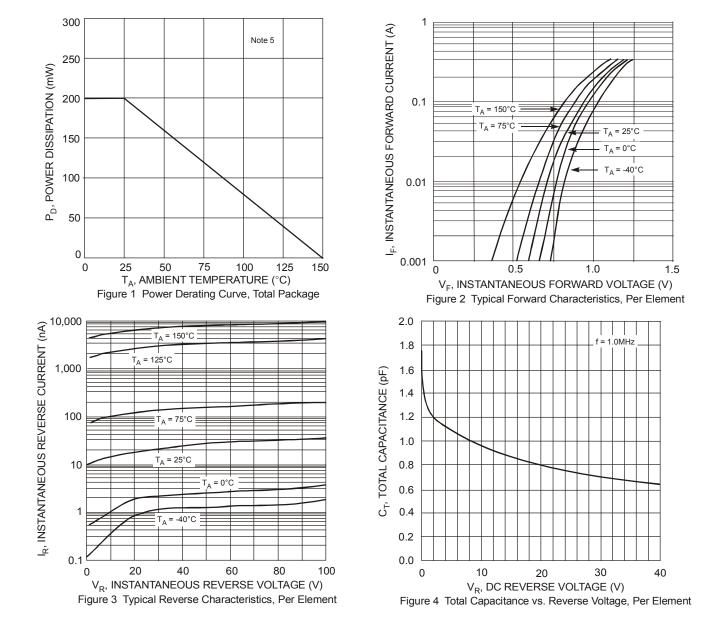
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition	
Reverse Breakdown Voltage	(Note 6)	V <sub>(BR)R</sub>	75	_	V	I <sub>R</sub> = 2.5μA
Forward Voltage		V <sub>F</sub>	_	0.715 0.855 1.0 1.25	V	$I_F = 1.0mA$ $I_F = 10mA$ $I_F = 50mA$ $I_F = 150mA$
Reverse Current	(Note 6)	I <sub>R</sub>	_	2.5 50 30 25	μΑ μΑ	V <sub>R</sub> = 75V V <sub>R</sub> = 75V, T <sub>J</sub> = +150°C V <sub>R</sub> = 25V, T <sub>J</sub> = +150°C V <sub>R</sub> = 20V
Total Capacitance		CT	_	2.0	pF	V <sub>R</sub> = 0, f = 1.0MHz
Reverse Recovery Time		t <sub>rr</sub>	—	4.0	ns	$I_{\rm F} = I_{\rm R} = 10 {\rm mA},$ $I_{\rm rr} = 0.1 \times I_{\rm R}, R_{\rm L} = 100 {\rm \Omega}$

Notes: 5. Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. 6. Short duration pulse test used to minimize self-heating effect.

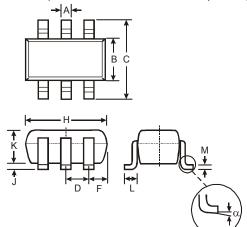


# BAW56DW



# **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

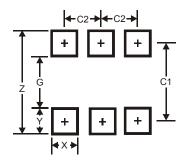


SOT363							
Dim	Min Max Typ						
Α	0.10	0.30	0.25				
В	1.15	1.35	1.30				
С	2.00	2.20	2.10				
D	0.65 Typ						
F	0.40 0.45 0.42						
Н	1.80	2.20	2.15				
J	0	0.10	0.05				
κ	0.90	1.00	1.00				
L	0.25	0.40	0.30				
М	0.10	0.22	0.11				
α	0°	8°	-				
All Dimensions in mm							



# Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)			
Z	2.5			
G	1.3			
Х	0.42			
Y	0.6			
C1	1.9			
C2	0.65			

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